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W. Daniel Swayze, Jr.
Texas Instruments Incorporated
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATION OF FACSIMILE TRANSMISSION	
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 Terrie Chambers	<u>2-3-05</u> Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input type="checkbox"/> AMENDMENT (# Pages)
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT (1 Month)
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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	<input type="checkbox"/> ADDRESS
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Yew	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/612,129 Filing Date: 7/2/2003	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
TI FILE NO.: TI-26239.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: <u>2-3-05</u> DUE: 01/12/2005 ATTY/SECY: WDS/tlc	

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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265

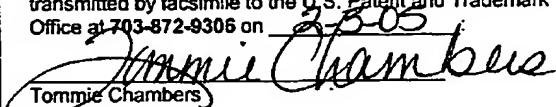
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yew
Serial No: 10/612,129
Filed: 7/2/2003
For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC
SUBSTRATE

Docket No: TI-26239.1
Examiner: Cao, Phat X.
Art Unit: 2814

EXTENSION OF TIME

Assistant Commissioner For Patents
Washington, DC 20231

<p>CERTIFICATION OF FACSIMILE TRANSMISSION</p> <p>I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on <u>2-5-05</u></p> <p> Tommie Chambers</p>

Dear Sir:

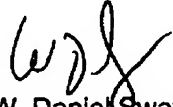
Pursuant to 37 CFR 1.136(a), Applicant(s) respectfully petition(s) the Commissioner for an extension of the shortened statutory period for response in the above identified Application.

The fee for this extension is indicated below:

<input checked="" type="checkbox"/> One Month (\$120)	<input type="checkbox"/> Three Months (\$1020)
<input type="checkbox"/> Two Months (\$450)	<input type="checkbox"/> Four Months (\$1590)

Any further necessary extension of time is hereby requested. Charge any and all fees, or credit any overpayment, to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

Respectfully submitted,


W. Daniel Swayze, Jr.
Attorney for Applicant
Reg. No. 34,478

Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265
(972) 917-5633